



SMD Comm X8G HT150C Flex, Ceramic, 36 pF, 20%, 200 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1210, 1.5 mm



| General Information      |  |
|--------------------------|--|
| Series                   | SMD Comm X8G HT150C Flex                     |
| Style                    | SMD Chip                                     |
| Description              | SMD, MLCC, High Temperature,<br>Ultra-Stable |
| Features                 | High Temperature, Ultra-Stable               |
| RoHS                     | Yes  |
| Termination              | Flexible Termination                         |
| Marking                  | No   |
| AEC-Q200                 | No   |
| Typical Component Weight | 30 mg  |
| Shelf Life               | 78 Weeks                                     |
| MSL                      | 1  |

36 pF

| Dimensions |                  |
|------------|------------------|
| Chip Size  | 1210             |
| L          | 3.3mm +/-0.4mm   |
| W          | 2.6mm +/-0.3mm   |
| Т          | 0.78mm +/-0.20mm |
| S          | 1.5mm MIN        |
| В          | 0.6mm +/-0.25mm  |

|                       | 3.3mm +/-0.4mm           | Measurement Condition                         | 1 MHz 1.0Vrms                                   |
|-----------------------|--------------------------|---|---|
|                       | 2.6mm +/-0.3mm           | Tolerance                                     | 20%   |
|                       | 0.78mm +/-0.20mm         | Voltage DC                                    | 200 VDC   |
|                       | 1.5mm MIN                | Dielectric Withstanding Voltage               | 500 VDC   |
|                       | 0.6mm +/-0.25mm          | Temperature Range                             | -55/+150°C                                      |
|                       |                          | Temp. Coefficient                             | X8G   |
| kaging Specifications |                          | Capacitance Change with                       | 30 ppm/C, 1MegaHz 1.0Vrms                       |
| kaging                | T&R, 330mm, Plastic Tape | Reference to +25°C and 0 VDC<br>Applied (TCC) |   |
| ing Quantity 10000    |                          |   |   |
| kaging Quantity       | 10000                    | Dissipation Factor                            | 0.1% 1 MHz 1.0Vrms                              |
| caging Quantity       | 10000                    | Dissipation Factor Aging Rate                 | 0.1% 1 MHz 1.0Vrms 0% Loss/Decade Hour: Referee |

**Specifications** 

Capacitance

| 3                        | I.SITIII IVIII V         | Dielectric Withstarialing Voltage             | 300 VDC  |
|--------------------------|--------------------------|---|--|
| В                        | 0.6mm +/-0.25mm          | Temperature Range                             | -55/+150°C   |
|                          |                          | Temp. Coefficient                             | X8G  |
| Packaging Specifications |                          | Capacitance Change with                       | 30 ppm/C, 1MegaHz 1.0Vrms                          |
| Packaging                | T&R, 330mm, Plastic Tape | Reference to +25°C and 0 VDC<br>Applied (TCC) |  |
| Packaging Quantity 10000 | 0000                     | Dissipation Factor                            | 0.1% 1 MHz 1.0Vrms                                 |
|                          |                          | Aging Rate                                    | 0% Loss/Decade Hour: Referee<br>Time is 1000 Hours |
|                          |                          | Insulation Resistance                         | 100 GOhms  |
|                          |                          |   |  |

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